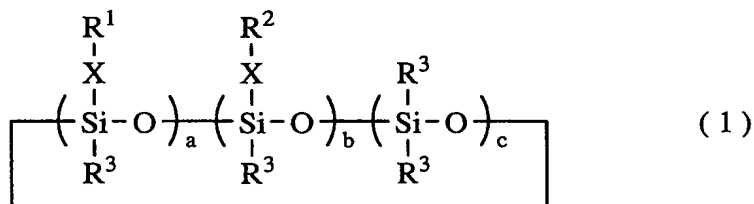


THERMAL CONDUCTIVE SILICONE COMPOSITION

Abstract

The present invention relates to a thermal conductive silicone composition ~~comprising~~containing a siloxane ~~containing~~which contains a hydrolytic group represented by the formula (1):



where:

~~R¹~~R¹ is a group containing an ~~alkoxysiloxy~~alkoxysilyl group having 1 to 4 carbon atoms,

~~R²~~R² is a ~~siloxane~~siloxyl represented by the following formula (2) or a monovalent hydrocarbon group having 6 to 18 carbon atoms,

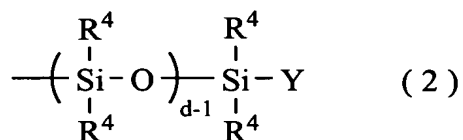
~~X~~X is a divalent hydrocarbon group having 2 to 10 carbon atoms,

a and ~~b~~b are integers of 1 or more,

~~c~~c is an integer of 0 or more,

the sum of a + b + ~~c~~c is an integer of 4 or more,

~~R³~~R³ is a monovalent hydrocarbon group having 1 to 6 carbon atoms or a hydrogen atom, provided that R³s may be the same as or different from each other;



~~R⁴~~R⁴ is a monovalent hydrocarbon group having 1 to 12 carbon atoms,

~~Y~~Y is a group selected from a methyl group, a vinyl group and R¹, and

~~d~~d is an integer of 2 to 500.